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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Obsolete
Core Processor	FR81S
Core Size	32-Bit Single-Core
Speed	80MHz
Connectivity	CANbus, CSIO, I ² C, LINbus, SPI, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	96
Program Memory Size	1.0625MB (1.0625M x 8)
Program Memory Type	FLASH
EEPROM Size	64K x 8
RAM Size	136K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 42x12b; D/A 2x8b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	120-LQFP
Supplier Device Package	120-LQFP (16x16)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb91f526jscpmc-gse2
Tarchase one	



Product lineup comparison 144 pins

Product lineup comparison 144 pins						
	MB91F522K	MB91F523K	MB91F524K	MB91F525K	MB91F526K	
System Clock	On chip PLL Clock multiple method					
Minimum instruction execution time	12.5ns (80MHz)					
Flash Capacity (Program)	(256+64)KB	(384+64)KB	(512+64)KB	(768+64)KB	(1024+64)KB	
Flash Capacity (Data)			64KB			
RAM Capacity	(48+	8)KB	(64+8)KB	(96+8)KB	(128+8)KB	
External BUS I/F			Yes			
(22address/16data/4cs)						
DMA Transfer			16ch			
16-bit Base Timer			2ch			
Free-run Timer		16	bit×3ch, 32bit×	3ch		
Input capture		16	bit×4ch, 32bit×	6ch		
Output Compare		16	bit×6ch, 32bit×	6ch		
16-bit Reload Timer			8ch			
PPG			16bit×44ch			
Up/down Counter			2ch			
Clock Supervisor			Yes			
External Interrupt			8ch×2units			
A/D converter		12bit×32cl	n (1unit), 12bit×	16ch (1unit)		
D/A converter (8bit)			2ch			
Multi-Function Serial Interface			12ch ^{*1}			
CAN		64m	sg×2ch/128ms	g×1ch		
Hardware Watchdog Timer			Yes			
CRC Formation			Yes			
Low-voltage detection reset			Yes			
Flash Security			Yes			
ECC Flash/WorkFlash			Yes			
ECC RAM			Yes			
Memory Protection Function (MPU)			Yes			
Floating point arithmetic (FPU)			Yes			
Real Time Clock (RTC)			Yes			
General-purpose port (#GPIOs)			120 ports			
SSCG			Yes			
Sub clock			Yes			
CR oscillator			Yes			
NMI request function			Yes			
OCD (On Chip Debug)			Yes			
TPU (Timing Protection Unit)	Yes					
Key code register	Yes					
Waveform generator	6ch					
Operation guaranteed temperature (T _A)	-40°C to +125°C					
Power supply			2.7V to 5.5V *			
Package		l	_QS144, LQN1	44		

^{*1:} Only channel 3 and channel 4 support the I²C (fast mode/standard mode).

Only channel 5, channel 6, channel 7, channel 8, channel 10 and channel 11 support the I²C (standard mode).

^{*2:} The initial detection voltage of the external low voltage detection is 2.8V±8% (2.576V to 3.024V). This LVD setting and internal LVD cannot be used to reliably generate a reset before voltage dips below minimum guaranteed operation voltage, as these detection levels are below the minimum guaranteed MCU operation voltage. Below the minimum guaranteed MCU operation voltage, MCU operations are not guaranteed with the exception of LVD.



		Pin	no.			Pin	Polarity	I/O circuit	Function*9
64	80	100	120	144	176	Name	_	types*8	
						P032	-		General-purpose I/O port
						A04 *2, *3, *4, *5	-		External bus/Address bit4 output (0)
5 *1	7 *1	9 *1	12 *1	15	19	SCS43_1	-	Α	Serial chip select 43 output (1)
						PPG30_0	-		PPG ch.30 output (0)
						TOT3_0	-		Reload timer ch.3 output (0)
						RTO2_1	-		Waveform generator ch.2 output pin (1)
						P033	-		General-purpose I/O port
						A05 *2, *3, *4, *5	-		External bus/Address bit5 output (0)
o *1	o *1	40 *1	40 *1	40		PPG31_0	-		PPG ch.31 output (0)
6 *1	8*1	10*1	13 ^{*1}	16	20	ICU3_3	-	Α	Input capture ch.3 input (3)
						TIN4_0	-		Reload timer ch.4 event input (0)
						RTO1_1	-		Waveform generator ch.1 output pin (1)
						SCK3_2	-		Multi-function serial ch.3 clock I/O (2)
						P034	-		General-purpose I/O port
						A06 *2, *3, *4, *5	-		External bus/Address bit6 output (0)
						OCU11_1	-		Output compare ch.11 output (1)
7 *1	9*1	11 *1	14 *1	17	21	ICU2_3	-	Α	Input capture ch.2 input (3)
						TIN5_0	-		Reload timer ch.5 event input (0)
						RTO0_1	-		Waveform generator ch.0 output pin (1)
						SOT3_2	-		Multi-function serial ch.3 serial data output (2)
						P150	-		General-purpose I/O port
						SOT8_0/ SDA8	-		Multi-function serial ch.8 serial data output (0)/ I ² C bus serial data I/O
_	-	12	15	18	22	OCU10_1	-	F	Output compare ch.10 output (1)
						TRG6_0	-		PPG trigger 6 input (0)
						ICU1_3	-		Input capture ch.1 input (3)
						TIN6_0	-		Reload timer ch.6 event input (0)
						P151	-		General-purpose I/O port
						SCK8_0/ SCL8 *2, *3	-		Multi-function serial ch.8 clock I/O (0)/ I ² C bus serial clock I/O
						OCU9_1	-		Output compare ch.9 output (1)
8 *1	10	13	16	19	23	TRG7_0	-	F	PPG trigger 7 input (0)
						ICU0_3	-		Input capture ch.0 input (3)
						TIN7_0	-		Reload timer ch.7 event input (0)
						ZIN0_2	-		U/D counter ch.0 ZIN input (2)
						DTTI_1	-		Waveform generator ch.1 input pin (1)



4. I/O Circuit Type

Type	Circuit	Remarks
А	Pull-up control Digital output Digital output Automotive input Standby control	•General-purpose I/O port •Output 4mA •Pull-up resistor control 50kΩ •Automotive input
В	Pull-up control Digital output Digital output Automotive input Standby control Analog input	•Analog input, General-purpose I/O port •Output 4mA •Pull-up resistor control 50kΩ •Automotive input
С	Pull-up control Digital output Automotive input Standby control DAC output	•DAC output, General-purpose I/O port •Output 4mA •Pull-up resistor control 50kΩ •Automotive input



■ Storage of Semiconductor Devices

Because plastic chip packages are formed from plastic resins, exposure to natural environmental conditions will cause absorption of moisture. During mounting, the application of heat to a package that has absorbed moisture can cause surfaces to peel, reducing moisture resistance and causing packages to crack. To prevent, do the following:

- (1) Avoid exposure to rapid temperature changes, which cause moisture to condense inside the product. Store products in locations where temperature changes are slight.
- (2) Use dry boxes for product storage. Products should be stored below 70% relative humidity, and at temperatures between 5°C and 30°C.
 - When you open Dry Package that recommends humidity 40% to 70% relative humidity.
- (3) When necessary, Cypress packages semiconductor devices in highly moisture-resistant aluminum laminate bags, with a silica gel desiccant. Devices should be sealed in their aluminum laminate bags for storage.
- (4) Avoid storing packages where they are exposed to corrosive gases or high levels of dust.

■ Baking

Packages that have absorbed moisture may be de-moisturized by baking (heat drying). Follow the Cypress recommended conditions for baking.

Condition: 125°C/24 h

■ Static Electricity

Because semiconductor devices are particularly susceptible to damage by static electricity, you must take the following precautions:

- (1) Maintain relative humidity in the working environment between 40% and 70%. Use of an apparatus for ion generation may be needed to remove electricity.
- (2) Electrically ground all conveyors, solder vessels, soldering irons and peripheral equipment.
- (3) Eliminate static body electricity by the use of rings or bracelets connected to ground through high resistance (on the level of 1 MΩ).
 - Wearing of conductive clothing and shoes, use of conductive floor mats and other measures to minimize shock loads is recommended.
- (4) Ground all fixtures and instruments, or protect with anti-static measures.
- (5) Avoid the use of styrofoam or other highly static-prone materials for storage of completed board assemblies.
- 3. Precautions for Use Environment

Reliability of semiconductor devices depends on ambient temperature and other conditions as described above.

For reliable performance, do the following:

(1) Humidity

Prolonged use in high humidity can lead to leakage in devices as well as printed circuit boards. If high humidity levels are anticipated, consider anti-humidity processing.

(2) Discharge of Static Electricity

When high-voltage charges exist close to semiconductor devices, discharges can cause abnormal operation. In such cases, use anti-static measures or processing to prevent discharges.

(3) Corrosive Gases, Dust, or Oil

Exposure to corrosive gases or contact with dust or oil may lead to chemical reactions that will adversely affect the device. If you use devices in such conditions, consider ways to prevent such exposure or to protect the devices.

(4) Radiation, Including Cosmic Radiation

Most devices are not designed for environments involving exposure to radiation or cosmic radiation. Users should provide shielding as appropriate.

Document Number: 002-04662 Rev. *D



A al al :		Address offset val	ue / Register name		Dii-
Address	+0	+1	+2	+3	Block
000000н	PDR00 [R/W] B,H,W XXXXXXXX	PDR01 [R/W] B,H,W XXXXXXXX	PDR02 [R/W] B,H,W XXXXXXXX	PDR03 [R/W] B,H,W XXXXXXXX	
000004 _H	PDR04 [R/W] B,H,W XXXXXXXX	PDR05 [R/W] B,H,W XXXXXXXX	PDR06 [R/W] B,H,W XXXXXXXX	PDR07 [R/W] B,H,W XXXXXXXX	
000008 _H	PDR08 [R/W] B,H,W XXXXXXXX	PDR09 [R/W] B,H,W XXXXXXXX	PDR10 [R/W] B,H,W XXXXXXXX	PDR11 [R/W] B,H,W XXXXXXXX	
00000C _H	PDR12 [R/W] B,H,W XXXXXXXX	PDR13 [R/W] B,H,W -XXXXXXX	PDR14 [R/W] B,H,W XXX	PDR15 [R/W] B,H,W XXXXXX	Port Data Register
000010 _H	_	_	_	_	
000014 _H	_	_	_	_	
000018 _H	PDR16 [R/W] B,H,W XXXXXXXX	PDR17 [R/W] B,H,W XXXXXXXX	PDR18 [R/W] B,H,W XXXXXXXX	PDR19 [R/W] B,H,W XXXXXXXX	
00001C _H to 000034 _H	_	_	_	_	Reserved
000038 _H	WDTECR0 [R/W] B,H,W 00000	_	_	_	Watchdog Timer
00003С _Н	WDTCR0 [R/W] B,H,W -00000	WDTCPR0 [W] B,H,W 00000000	WDTCR1 [R] B,H,W 0110	WDTCPR1 [W] B,H,W 00000000	[S]
000040 _H	_	_	_	_	Reserved
000044 _H	DICR [R/W] B,H,W 0	_	_	_	Delayed Interrup
000048 _Н to 00005С _Н	_	_	_	_	Reserved
000060н	TMRLRA0 (R/W) H TMR0 (R) H		• •		
000064н	TMRLRB0 (R/W) H		TMCSR0 [R/W] B,H,W 00000000 0-000000		Reload Timer 0
000068н	TMRLRA7 [R/W] H XXXXXXXX XXXXXXX		TMR7 XXXXXXXX	Delegal Times 7	
00006С _н	TMRI RR7 (R/W) H		TMCSR7 [F	Reload Timer 7	
000070 _H	_		FRS8 [R/W] B,H,W 00000000000	Free-run timer selection register 8	



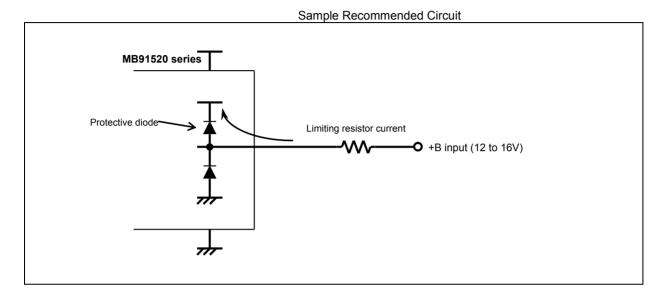
Address	+0 +1		+2	Block	
001AD0 _H	PCN6 [R/W 00000000 0	•		S [W] H,W X XXXXXXX	
001AD4 _Н	PDUT6 [M XXXXXXXX X	-		6 [R] H,W 1 11111111	DDCC
001AD8 _н	PCN206 [R/V 000000 -	-		[R/W] H,W 0 00000000	PPG6
001ADC _н	PTPC6 [R/\ 00000000 00	-	-	_	
001AE0 _н	PCN7 [R/W 00000000 0	_		7 [W] H,W X XXXXXXX	
001AE4 _н	PDUT7 [M XXXXXXXX X			7 [R] H,W 1 11111111	PPG7
001AE8 _н	PCN207 [R/V 000000 -	- · · · · ·		[R/W] H,W 0 00000000	
001AEC _н	PTPC7 [R/\ 00000000 00	-	1	_	
001AF0 _н	PCN8 [R/W 00000000 0	•	PCSR8 [W] H,W XXXXXXXX XXXXXXX		
001AF4 _н	PDUT8 [W] H,W XXXXXXXX XXXXXXX		PTMR8 [R] H,W 11111111 11111111		PPG8
001AF8 _н	PCN208 [R/W] B,H,W 000000110		PSDR8 [R/W] H,W 00000000 00000000		PPGo
001AFC _н	PTPC8 [R/\ 00000000 00	-	_	_	
001В00н	PCN9 [R/W 00000000 0			P [W] H,W X XXXXXXX	
001B04 _Н	NJ etudq XXXXXXXX	<u> </u>	PTMR9 [R] H,W 11111111 11111111		PPG9
001B08 _Н	PCN209 [R/V 000000 -	110		[R/W] H,W 0 00000000	
001B0С _н	PTPC9 [R/\ 00000000 00	000000	_	_	
001B10 _Н	10 _H PCN10 [R/W] B,H,W 00000000 000000-0			0 [W] H,W X XXXXXXX	DDC10
001В14 _Н	PDUT10 [W] H,W XXXXXXXX XXXXXXX		PTMR10 [R] H,W 11111111 11111111		PPG10
001В18 _Н	PCN210 [R/W] B,H,W 000000110			[R/W] H,W 0 00000000	DDC40
001B1C _н	PTPC10 [R/ 00000000 00		_	_	PPG10
001В20 _Н	PCN11 [R/W 00000000 0	-		1 [W] H,W X XXXXXXX	PPG11



Address	+0	+1	+2	+3	Block
001ВССн	PTPC21 [F	- ·	_	_	PPG21
001ВD0н	PCN22 [R/ 00000000			22 [W] H,W X XXXXXXX	
001BD4 _Н	PDUT22 XXXXXXXX			22 [R] H,W 11 11111111	PPG22
001BD8 _н	PCN222 [R 000000	-		2 [R/W] H,W 00 00000000	
001BDC _н	PTPC22 [F 00000000	- ·	_	_	
001BE0 _н	PCN23 [R/ 00000000	- · · · · · · · · · · · · · · · · · · ·		23 [W] H,W X XXXXXXXX	
001BE4 _н	PDUT23 XXXXXXXX			23 [R] H,W 11 11111111	PPG23
001BE8 _н	PCN223 [R 000000			3 [R/W] H,W 00 00000000	— FFG23
001BEC _н	PTPC23 [F 00000000	- ·	_	_	
001BF0 _Н	PCN24 [R/ 00000000	- · · · · · · · · · · · · · · · · · · ·	PCSR24 [W] H,W XXXXXXXX XXXXXXX		
001BF4 _н	PDUT24 [W] H,W XXXXXXXX XXXXXXX		PTMR24 [R] H,W 11111111 11111111		PPG24
001BF8 _н	PCN224 [R 000000	•	PSDR24 [R/W] H,W 00000000 00000000		
001BFC _н	PTPC24 [F 00000000	•	_	_	
001С00н	PCN25 [R/ 00000000	•		25 [W] H,W X XXXXXXXX	
001С04 _н	PDUT25 XXXXXXXX		PTMR25 [R] H,W 11111111 11111111		PPG25
001С08 _Н	PCN225 [R 000000			PSDR25 [R/W] H,W 00000000 00000000	
001С0С _н	PTPC25 [F 00000000		_	_	
001С10 _н	PCN26 [R/W] B,H,W 00000000 000000-0 PDUT26 [W] H,W XXXXXXXX XXXXXXX PCN226 [R/W] B,H,W 000000110			26 [W] H,W XX XXXXXXXX	
001C14 _H				26 [R] H,W 11 11111111	PPG26
001C18 _H			PSDR26 [R/W] H,W 00000000 00000000		
001С1С _н	PTPC26 [F 00000000	•	_	_	
001С20 _Н	PCN27 [R/ 00000000	- · · · · · · · · · · · · · · · · · · ·		27 [W] H,W X XXXXXXXX	PPG27



- *8: It is a standard when four-layer substrate is used.
- *9: Corresponding pins: General-purpose ports other than those of P103, P104, P105 and P106.
- *10: Corresponding pins: General-purpose ports of P103, P104, P105 and P106.



<WARNING>

Semiconductor devices may be permanently damaged by application of stress (including, without limitation, voltage, current or temperature) in excess of absolute maximum ratings. Do not exceed any of these ratings.

Recommended operating conditions

 $(V_{SS}=AV_{SS}=0.0V)$

Domenator	Symbol Value Unit		I I m i 4	Remarks	
Parameter			Unit	Remarks	
	.,,	4.5	5.5	V	Recommended operation guarantee range (When 5.0V is used)
Power supply voltage	V _{cc,} AV _{cc}	3.0	3.6	V	Recommended operation guarantee range (When 3.3V is used)
		2.7	5.5	V	Operation guarantee range*1
Smoothing capacitor *2	Cs	4.7 (tolerance within ±50%)		μF	Use a ceramic capacitor or a capacitor that has the similar frequency characteristics. Use a capacitor with a capacitance greater than C _S as the smoothing capacitor on the VCC pin.
On a ration at the man a rational	_	-40	+105	°C	
Operating temperature	T _A	-40	+125	°C	*3

^{*1:} When it is used outside recommended operation guarantee range (range of the operation guarantee),contact your sales representative.

The initial detection voltage of the external low voltage detection is 2.8V±8% (2.576V to 3.024V). This LVD setting and internal LVD cannot be used to reliably generate a reset before voltage dips below minimum guaranteed operation voltage, as these detection levels are below the minimum guaranteed MCU operation voltage. Below the



(4-4) I²C timing

 $(T_A: -40^{\circ}C \text{ to } +125^{\circ}C, V_{CC}=AV_{CC}=5.0V \pm 10\%/V_{CC}=AV_{CC}=3.3V \pm 0.3V, V_{SS}=AV_{SS}=0.0V)$

Dorometer	Symb	Symb	Conditions	Standard mode		Fast mode*3		Unit	Domorko
Parameter	ol	Pin name	Conditions	Min Max		Min	Max	Unit	Remarks
SCL clock frequency	f _{SCL}	SCK3 to SCK11		0	100	0	400	kHz	
Repeat "start" condition hold time SDA $\downarrow \rightarrow$ SCL \downarrow	thdsta	SOT3 to SOT11, (SDA) SCK3 to SCK11, (SCL)		4.0	_	0.6	_	μs	
Period of "L" for SCL clock	t _{LOW}	SCK3 to SCK11, (SCL)		4.7	_	1.3	_	μs	
Period of "H" for SCL clock	t _{HIGH}	SCK3 to SCK11, (SCL)		4.0	_	0.6	_	μs	
Repeat "start" condition setup time $\label{eq:SCL} SCL \uparrow \to SDA \downarrow$	t _{SUSTA}	SCK3 to SCK11, (SCL)		4.7	_	0.6	-	μs	
Data hold time $SCL\downarrow \to SDA\downarrow \uparrow$	t _{HDDAT}	SOT3 to SOT11, (SDA) SCK3 to SCK11, (SCL)	$C_L=50pF$ $R = (V_P/I_{OL})^{*1}$	0	3.45 ^{*2}	0	0.9*3	μs	
Data setup time SDA $\downarrow \uparrow \rightarrow$ SCL \uparrow	t _{SUDAT}	SOT3 to SOT11, (SDA) SCK3 to SCK11, (SCL)		250	-	100	_	ns	
"Stop" condition setup time SCL $\uparrow \rightarrow$ SDA \uparrow	tsusто	SOT3 to SOT11, (SDA) SCK3 to SCK11, (SCL)		4.0	_	0.6	-	μs	
Bus-free time between "stop" condition and "start" condition	t _{BUF}	_		4.7	_	1.3	_	μs	
Noise filter	t _{SP}	_	_	2t _{CPP} *4	_	2t _{CPP} *4	_	ns	

Notes: Only ch.3 and ch.4 are standard mode/fast mode correspondence. In ch.5-ch.8, ch.10, and ch.11, only a standard mode is correspondences.

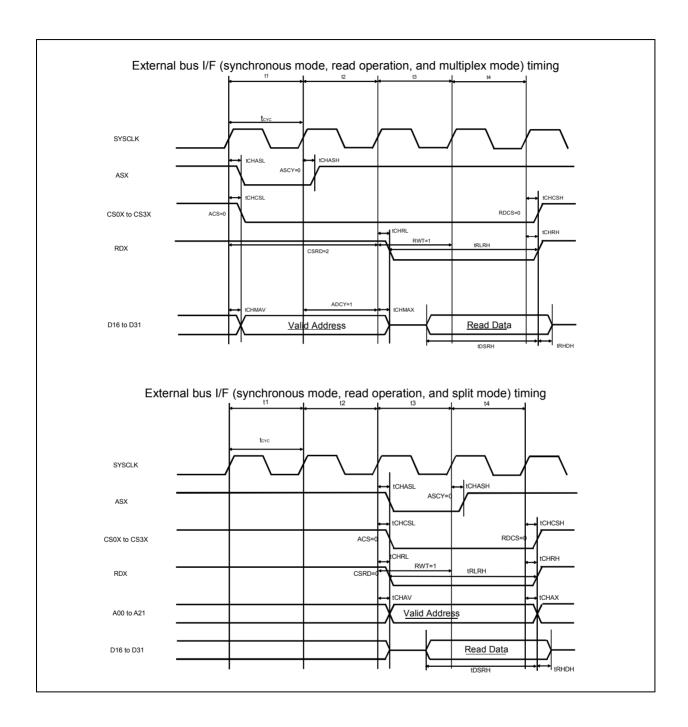
^{*1:} R and C_L represent the pull-up resistance and load capacitance of the SCL and SDA output lines, respectively.

Vp shows that the power-supply voltage of the pull-up resistor and I_{OL} shows the V_{OL} guarantee current.

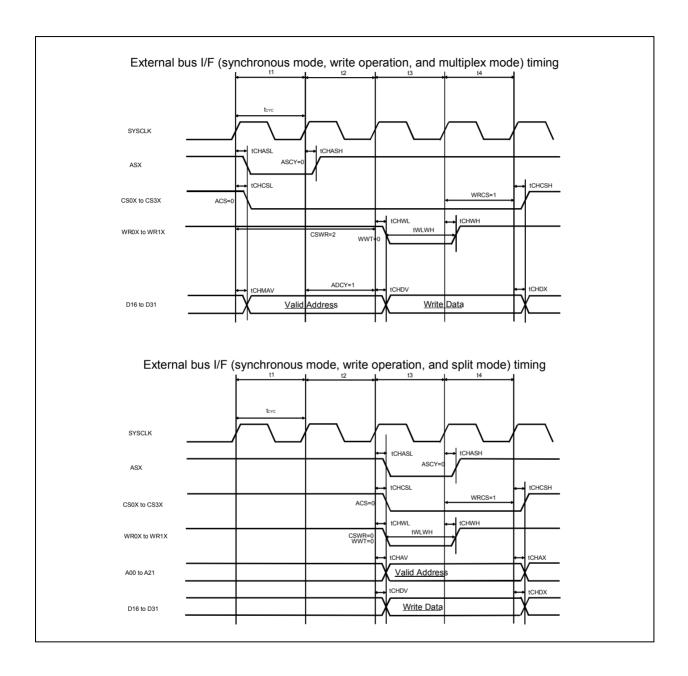
^{*2:} The maximum t_{HDDAT} only has to be met if the device does not extend the "L" width (t_{LOW}) of the SCL signal.

^{*3:} A fast mode I²C bus device can be used on a standard mode I²C bus system as long as the device satisfies the requirement of







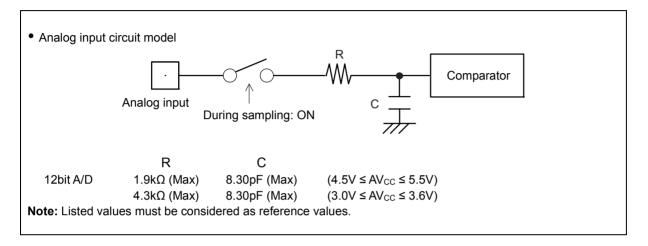




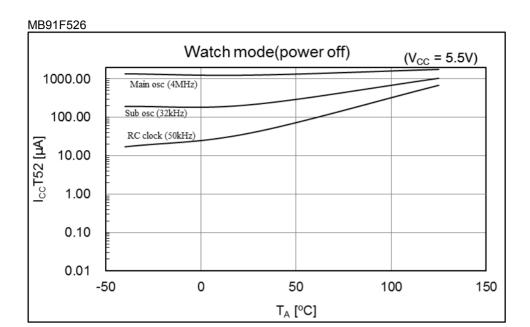
(3) Notes on Using A/D Converter

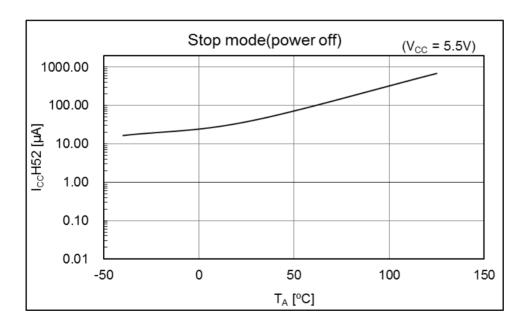
<About the output impedance of the analog input of external circuit>

When the external impedance is too high, the sampling period for analog voltages may not be sufficient. In this case, it is recommended to connect the capacitor (approx. $0.1 \mu F$) to the analog input pin.











14. Ordering Information MB91F52xxxC*1

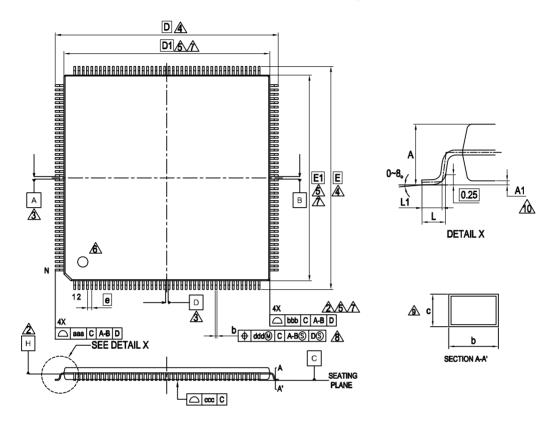
Part number	Sub clock	CSV Initial value	LVD Initial value	Package ^{*2}
MB91F526LWCPMC	Yes	ON	ON	
MB91F526LYCPMC			OFF	
MB91F526LJCPMC		OFF	ON	
MB91F526LLCPMC			OFF	
MB91F525LWCPMC		ON	ON	
MB91F525LYCPMC			OFF	
MB91F525LJCPMC		OFF	ON	
MB91F525LLCPMC			OFF	
MB91F524LWCPMC		ON	ON	
MB91F524LYCPMC			OFF	
MB91F524LJCPMC		OFF	ON	
MB91F524LLCPMC			OFF	
MB91F523LWCPMC		ON	ON	
MB91F523LYCPMC			OFF	
MB91F523LJCPMC		OFF	ON	
MB91F523LLCPMC			OFF	
MB91F522LWCPMC		ON	ON	
MB91F522LYCPMC			OFF	
MB91F522LJCPMC		OFF	ON	
MB91F522LLCPMC			OFF	LQP·176 pin,
MB91F526LSCPMC	None	ON	ON	Plastic
MB91F526LUCPMC			OFF	
MB91F526LHCPMC		OFF	ON	
MB91F526LKCPMC			OFF	
MB91F525LSCPMC		ON	ON	
MB91F525LUCPMC			OFF	
MB91F525LHCPMC		OFF	ON	
MB91F525LKCPMC			OFF	
MB91F524LSCPMC		ON	ON	
MB91F524LUCPMC			OFF	
MB91F524LHCPMC		OFF	ON	
MB91F524LKCPMC			OFF	
MB91F523LSCPMC		ON	ON	
MB91F523LUCPMC			OFF	
MB91F523LHCPMC		OFF	ON	
MB91F523LKCPMC			OFF	
MB91F522LSCPMC		ON	ON	
MB91F522LUCPMC			OFF	
MB91F522LHCPMC		OFF	ON	
MB91F522LKCPMC			OFF	



Part number	Sub clock	CSV Initial value	LVD Initial value	Package*
MB91F526FWDPMC	Yes	ON	ON	
MB91F526FJDPMC		OFF	ON	
MB91F525FWDPMC		ON	ON	
MB91F525FJDPMC		OFF	ON	
MB91F524FWDPMC		ON	ON	
MB91F524FJDPMC		OFF	ON	
MB91F523FWDPMC		ON	ON	
MB91F523FJDPMC		OFF	ON	
MB91F522FWDPMC		ON	ON	
MB91F522FJDPMC		OFF	ON	LQI • 100 pin, Plastic
MB91F526FSDPMC	None	ON	ON	Plastic
MB91F526FHDPMC		OFF	ON	
MB91F525FSDPMC		ON	ON	
MB91F525FHDPMC		OFF	ON	
MB91F524FSDPMC		ON	ON	
MB91F524FHDPMC		OFF	ON	
MB91F523FSDPMC		ON	ON	
MB91F523FHDPMC		OFF	ON	
MB91F522FSDPMC		ON	ON	
MB91F522FHDPMC		OFF	ON	
MB91F526DWDPMC	Yes	ON	ON	
MB91F526DJDPMC		OFF	ON	
MB91F525DWDPMC		ON	ON	
MB91F525DJDPMC		OFF	ON	
MB91F524DWDPMC		ON	ON	
MB91F524DJDPMC		OFF	ON	
MB91F523DWDPMC		ON	ON	
MB91F523DJDPMC		OFF	ON	
MB91F522DWDPMC		ON	ON	
MB91F522DJDPMC		OFF	ON	LQH · 80 pin,
MB91F526DSDPMC	None	ON	ON	Plastic
MB91F526DHDPMC		OFF	ON	
MB91F525DSDPMC		ON	ON	
MB91F525DHDPMC		OFF	ON	
MB91F524DSDPMC]	ON	ON	
MB91F524DHDPMC		OFF	ON	
MB91F523DSDPMC		ON	ON	
MB91F523DHDPMC		OFF	ON	
MB91F522DSDPMC]	ON	ON	
MB91F522DHDPMC		OFF	ON	



LQP176, 176 Lead Plastic Low Profile Quad Flat Package



PACKAGE		LQP176				
SYMBOL	MIN.	MIN. NOM. MAX				
A	_	_	1.70			
A1	0.00	_	0.20			
b	0.17	0.22	0.27			
С	0.09		0.20			
D	2	6.00 BSC	;;			
D1	2	4.00 BSC	```			
е		0.50 BSC	;			
E	2	6.00 BSC	```			
E1	2	4.00 BSC	**			
L	0.45	0.60	0.75			
L1	0.30	0.50	0.70			
aaa	_	_	0.20			
bbb	_	_	0.10			
ccc	<u> </u>					
ddd			0.08			
N		176				

NOTES

- CONTROLLING DIMENSIONS ARE IN MILLIMETERS (mm)
 DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
- ADATUMS A-B AND D TO BE DETERMINED AT DATUM PLANE H.
- TO BE DETERMINED AT SEATING PLANE C.
- ⚠DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION.
 ALLOWABLE PROTRUSION IS 0.25mm PRE SIDE.
 DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
- (A) DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
- REGARDLESS OF THE RELATIVE SIZE OF THE UPPER AND LOWER BODY SECTIONS. DIMENSIONS D1 AND E1 ARE DETERMINED AT THE LARGEST FEATURE OF THE BODY EXCLUSIVE OF MOLD FLASH AND GATE BURRS. BUT INCLUDING ANY MISMATCH BETWEEN THE UPPER AND LOWER SECTIONS OF THE MOLDER BODY.
- ⚠DIMENSION 6 DOES NOT INCLUDE DAMBER PROTRUSION. THE DAMBAR PROTRUSION (S) SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED 6 MAXIMUM BY MORE THAN 0.08mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT.
- THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm AND 0.25mm FROM THE LEAD TIP.
- 1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.



Page	Section	Change Results							
		A List of "Pin Description" modified.							
		(Error)							
		(Little)	Pin						
		64	80	Pin 100	120	144	176	Name	
								P047	
			18	23	27	30	37	A17	
		15						AN45	
								TRG8_0	
								TIN3_2	
								SOT0_1 P177	
		-	-	-	-	-	38	TRG11_0	
			-	-	28	31	39	P050	
								A18	
								TRG5_1	
								PPG33_0	
			-	-	-	32	40	P051 A19	
		-						TRG9 0	
			-	1	-	33		P052	
							44	A20	
	■PIN Description	-		-			41	PPG34_0	
23, 24								INT14_0	
			19	24	29	34	42	P053	
								A21 AN44	
		16						PPG35_0	
								INT14_1	
								SCK0_1	
			-	-	-	35	43	P054	
		-						SYSCLK	
								PPG36_0	
			22	27	32	38	46	P055 CS2X	
								SIN10_0	
		17						AN43	
								PPG37_0	
		<u> </u>						TIN4_1	
								Doso	
			- -	-	- 33	39		P056 CS3X	
							49	ICU9_0	
								PPG0_1	
								ICU0_1	
								TIN5_1	
								DTTI_2	



Page	Section	Change Results							
		A List of "Pin Description" modified.							
	■PIN Description	(Error)							
		Pin no. Pir							
		64	80	100	120	144	176	Name P100	
		-	48	59	69	85	104	SCK7_0/ SCL7 AN12 PPG8_0	
		40	49	61	71	87	106	P102 SIN7_0 AN14 PPG10_0 INT10_0	
		41	50	62	72	88	107	P103 SCS73_0 AN15 PPG11 0	
		42	51	63	73	89	108	P104 SCS72_0 AN16 PPG12_0	
		43	52	64	74	90	109	P105 SCS71_0 AN17 PPG13_0	
30		(Correct)							
		64	80	Pin 100	no.	144	176	Pin Name	
		-	48 *1	59	69	85	104	P100 SCK7_0/ SCL7 ⁻³ AN12 PPG8_0	
		40 *1	49 ^{*1}	61	71	87	106	P102 SIN7_0 *2, *3 AN14 PPG10_0 INT10_0	
		41*1	50 *1	62	72	88	107	P103 SCS73_0 ^{-2, -3} AN15 PPG11_0	
		42*1	51 *1	63	73	89	108	P104 SCS72_0 2, 3 AN16 PPG12_0	
		43 *1	52 ^{*1}	64	74	90	109	P105 SCS71_0 ^{*2,*3} AN17 PPG13_0	
]					- <u></u>		



Page	Section	Change Results					
125	■Interrupt Vector Table	The following sentence deleted from Interrupt vector 80pins. (Error) *5: It does not support the DMA transfer by the interrupt because of the RAM ECC bit error.					
129	■Interrupt Vector Table	The interrupt factor in Interrupt vector 100pin modified as follows: (Error) Base timer 0 IRQ0 Base timer 0 IRQ1 60 C A44 GOOF FFOC H 1000F FFOC H 100					
129	■Interrupt Vector Table	The interrupt factor in Interrupt vector 100pin modified as follows: (Error) Base timer 1 IRQ0 Base timer 1 IRQ1 (Correct) Base timer 1 IRQ0 Base timer 1 IRQ0 Base timer 1 IRQ0 Base timer 1 IRQ1					
129	■Interrupt Vector Table	The following sentence deleted from Interrupt vector 100pins. (Error) *5: It does not support the DMA transfer by the interrupt because of the RAM ECC bit error.					



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